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U.S. DEPARTMENT OF COMMERCE  
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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of conveying party(ies):**  
Yoshiteru Kamatani (04/08/2008), Nozomu Ozaki (04/09/2008), Masamichi Asukai (04/14/2008), Taiji Ito (04/14/2008),  
Additional name(s) of conveying party(ies) attached?  Yes  No

**2. Name and address of receiving party(ies)**  
Name: Sony Corporation  
Internal Address: \_\_\_\_\_  
Street Address: \_\_\_\_\_

**3. Nature of conveyance/Execution Date(s):**  
Execution Date(s): in parentheses after inventor name  
 Assignment  Merger  Change of Name  
 Security Agreement  Joint Research Agreement  
 Government Interest Assignment  
 Executive Order 9424, Confirmatory License  
 Other \_\_\_\_\_

1-7-1 Konan, Minato-ku  
Tokyo, 108-0075  
JAPAN  
City: \_\_\_\_\_  
State: \_\_\_\_\_  
Country: \_\_\_\_\_ Zip: \_\_\_\_\_  
Additional name(s) & address(es) attached:  Yes  No

**4. Application or patent number(s):**  This document is being filed together with a new application.  
A. Patent Application No.(s)  
This application  
05/21/2008 S\$ITHIB1 00000003 12152927  
04 FC:8021  
40.00 0p Additional numbers attached?  Yes  No

B. Patent No.(s)  
 Yes  No

**5. Name and address to whom correspondence concerning document should be mailed:**  
Name: Randy J. Pritzker  
WOLF, GREENFIELD & SACKS, P.C.  
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State: MA Zip: 02210-2206  
Phone Number: 617.646.8000  
Fax Number: 617.646.8646  
Email Address: rpritzker@wolfgreenfield.com

**6. Total number of applications and patents involved:** 1  
**7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00**  
 Authorized to be charged by credit card  
 Authorized to be charged to deposit account  
 Enclosed  
 None required (government interest not affecting title)

**8. Payment Information**  
a. Credit Card Last 4 Numbers \_\_\_\_\_  
Expiration Date \_\_\_\_\_  
b. Deposit Account Number \_\_\_\_\_  
Authorized User Name \_\_\_\_\_

**9. Signature:**  
Randy J. Pritzker 5-19-08  
Signature Date  
Randy J. Pritzker - 35,986  
Name of Person Signing  
Total number of pages including cover sheet, attachments, and documents: 5

Express Mail Label No. EM 130468109 US Dated: 5/19/08

**Additional Conveying Party(ies)/Execution Date(s) (1. Continued):**

Akinobu Sugino (04/14/2008), Hidehiko Sekizawa (04/11/2008), Akane Sano (04/15/2008), Hirotaka Sakaguchi (04/15/2008), and Yoichiro Sako (05/08/2008)

**Additional Assignees (2. Continued):**

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Internal Address:

Street Address:

City: \_\_\_\_\_ State: \_\_\_\_\_ Country: \_\_\_\_\_ Zip: \_\_\_\_\_

**Additional Applications and/or Patents (4. Continued):**Additional Patent Application Numbers  
4A. Continued:Additional Patent Numbers  
4B. Continued:

Additional numbers attached?

Yes

No

Docket Number: \_\_\_\_\_

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGING PREVENTING APPARATUS AND IMAGING PREVENTING METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention and applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissues or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require, to be prepared at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date in this application in the spaces that follow: Serial Number: \_\_\_\_\_, Filing Date: \_\_\_\_\_.

This assignment executed on the dates indicated below.

Yoshiteru KAMATANI

Name of first or sole inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of first or sole inventor

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*April 8, 2008*

Signature of first or sole inventor

Date of this assignment

Nozomu OZAKI

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Date of this assignme


Masamichi ASUKAI

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Signature of third inventor

April 14, 2008

Date of this assignme

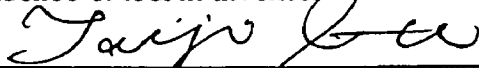
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Akinobu SUGINO

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Signature of ninth inventor

Date of this assignme

PATENT

RECORDED: 05/19/2008

REEL: 021087 FRAME: 0484